

N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
60	0.075 at V _{GS} = 10 V	4.0	2.1 nC		
60	0.086 at V_{GS} = 4.5 V	3.8	2.1110		

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TO-236 (SOT23)

Top View

G 1

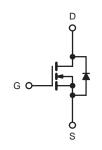
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FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested ٠
- 100 % UIS Tested •

APPLICATIONS

- Battery Switch
- DC/DC Converter



N-Channel MOSFET

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	60	V	
Gate-Source Voltage	V _{GS}	± 20	v	
	T _C = 25 °C		4.0	
Continuous Drain Current (T ₁ = 150 °C)	T _C = 70 °C	1-	3.4	
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	3.1 ^{b, c}	
	T _A = 70 °C		2.5 ^{b, c}	A
Pulsed Drain Current	I _{DM}	12	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	1-	1.39	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.91 ^{b, c}	
Avalanche Current		I _{AS}	6	
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	1.8	mJ
	T _C = 25 °C		1.66	
Maximum Dawar Dissinction	T _C = 70 °C	P	1.06	w
Maximum Power Dissipation	T _A = 25 °C	P _D	1.09 ^{b, c}	vv
	T _A = 70 °C		0.7 ^{b, c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS	
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Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, d}	≤ 5 s	R _{thJA}	90	115	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60	75	C/W

Notes:

a. Based on T_C = 25 °C. b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under Steady State conditions is 120 °C/W.

COMPLIANT HALOGEN FREE Available



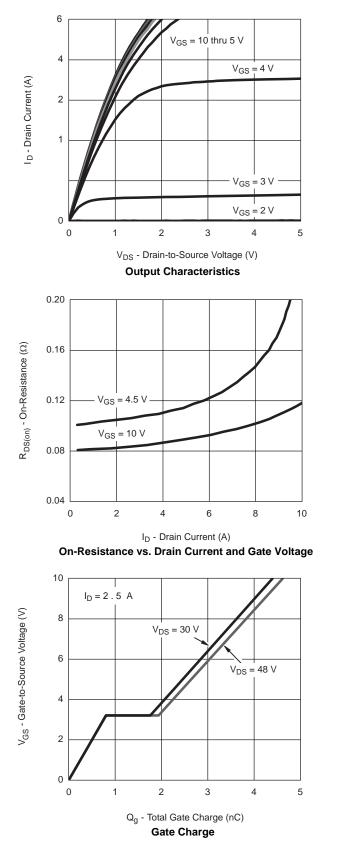
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-				1	1	
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			55		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zana Cata Maltana Duain Cumant	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	V _{GS} = 0 V		1		
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	8			Α	
		V _{GS} = 10 V, I _D = 1.9 A		0.075		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 1.7 A		0.086			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15V, I _D = 1.9 A		5		S	
Dynamic ^b					<u> </u>		
Input Capacitance	C _{iss}			180			
Output Capacitance	C _{oss}	· · · · · · · · · · · · · · · · · · ·		22		- pF	
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		13			
	$Q_{g} = \frac{V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.9 \text{ A}}{1000 \text{ V}}$	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 1.9 \text{ A}$		4.2	6.1		
Total Gate Charge			2.1	3.2	1		
Gate-Source Charge	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 4.5$ V, $I_{D} = 1.9$ A		0.7		- nC	
Gate-Drain Charge	Q _{gd}			1			
Gate Resistance	R _g	f = 1 MHz	0.6	2.2	5.1	Ω	
Turn-On Delay Time	t _{d(on)}			4	6		
Rise Time	t _r	V_{DD} = 30 V, R_{L} = 20 Ω		10	15	- ns	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}{\cong}\text{1.5}$ A, V_GEN = 10 V, R_G = 1 Ω		10	15		
Fall Time	t _f			7	10.5		
Turn-On Delay Time	t _{d(on)}			15	23		
Rise Time	tr	V_{DD} = 30 V, R_{L} = 20 Ω		16	24	- ns	
Turn-Off Delay Time	t _{d(off)}	I_{D} = 1.5 A, V_{GEN} = 4.5 V, R_{G} = 1 Ω		11	17		
Fall Time	t _f			11	17		
Drain-Source Body Diode Characteristic	s				1	1	
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			2.19	•	
Pulse Diode Forward Current ^a	I _{SM}				7	A	
Body Diode Voltage	V _{SD}	I _S = 1.5 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	23	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			10	15	nC	
Reverse Recovery Fall Time	ta	I _F = 1.5 A, dl/dt = 100 A/μs, T _J = 25 °C		12			
Reverse Recovery Rise Time	t _b			3		ns	

Notes:

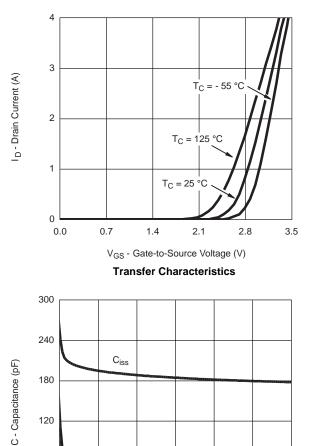
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

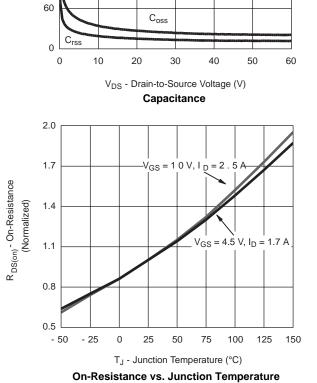




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

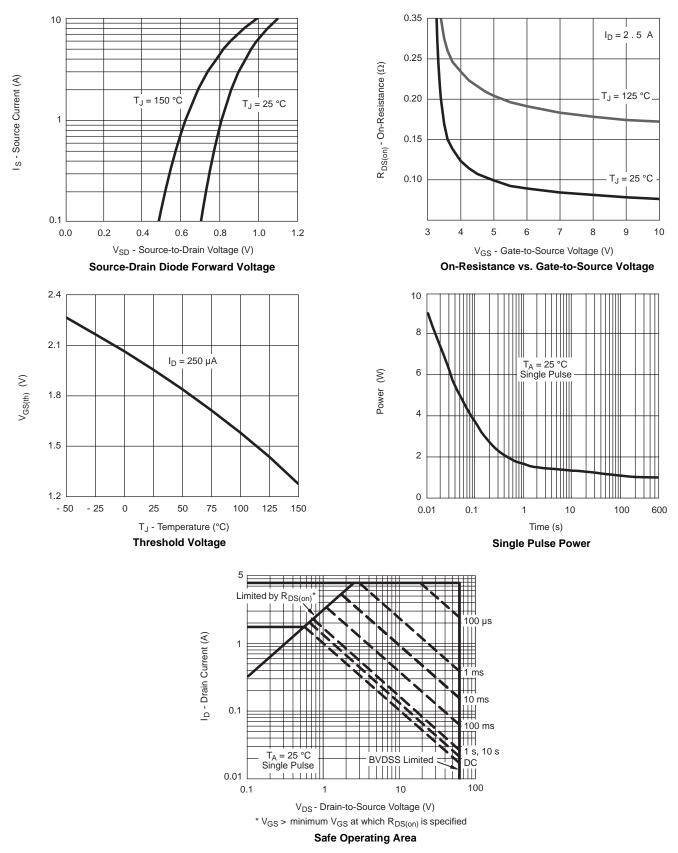


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服务热线:400-655-8788

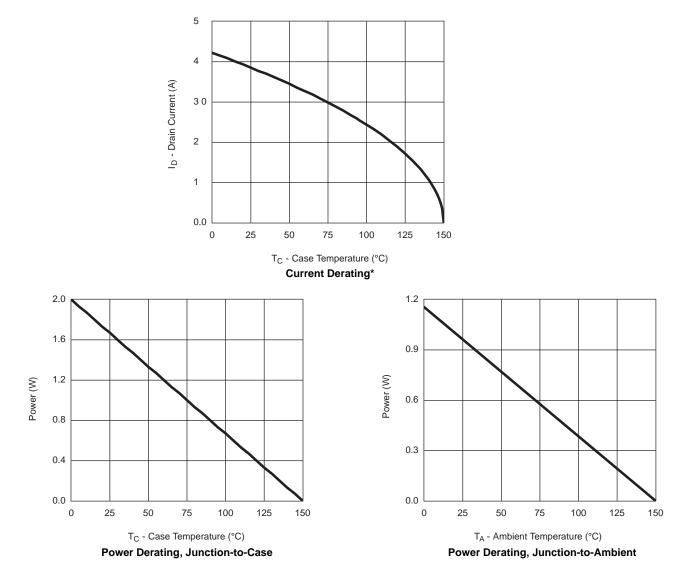




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

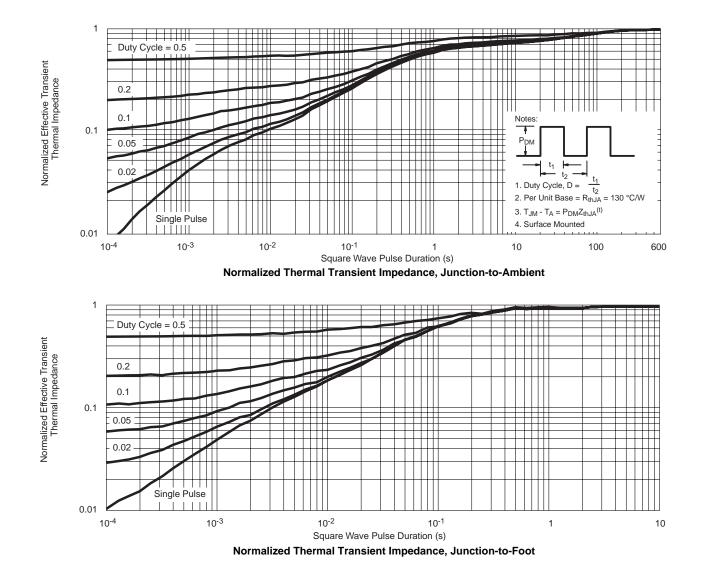


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



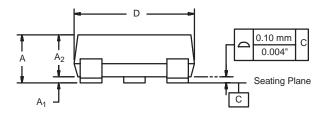


THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



SOT-23 (TO-236): 3-LEAD



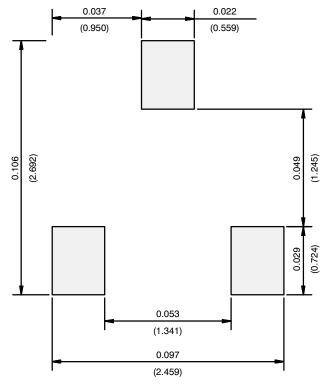




A A A ₁	Min 0.89	Max	Min	Мах	
	0.80			max	
Δ.	0.03	1.12	0.035	0.044	
~1	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
с	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95	BSC	0.0374	Ref	
e ₁	1.90 BSC		90 BSC 0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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